



2021 Orlando™

# 2021 International Conference on Compound Semiconductor Manufacturing Technology

May 24<sup>th</sup> - 27<sup>th</sup>, 2021

Hyatt Regency Grand Cypress  
Orlando, FL, USA

*Happy Holidays!*

# Final Call For Papers

Photo Courtesy of Walt Disney World Resort

Visit [csmantech.org](http://csmantech.org) to submit

**Abstracts Now Due  
January 22<sup>nd</sup> 2021**

**CS MANTECH will take place in 2021!  
Abstract submission is open  
Deadline extended!**

**Don't miss the opportunity  
to present at this  
one-of-a-kind technical &  
networking conference!**

Visit [csmantech.org](http://csmantech.org) for link to submit a 1-2 page abstract

### Abstracts should clearly state:

- The purpose of the work
- How CS Manufacturing Technology was used or advanced
- Specific results & how they were achieved with supporting data

Abstract formatting guidelines located at:  
[csmantech.org/authorkit/](http://csmantech.org/authorkit/)

### Conference Chair

Thorsten Saeger  
chairman@csmantech.org

### Technical Program Chair

Peter Ersland  
tpcchair@csmantech.org

In view of the evolving situation with COVID-19, the format of the conference may change. Options being evaluated are:

- **In-person:** traditional conference format if health and travel issues are resolved
- **Virtual:** Online conference format
- **Hybrid:** Combined in-person/virtual format for speakers and attendees

Abstracts are being accepted now; the conference Executive Committee will finalize the conference format by March 5<sup>th</sup>, 2021

### Papers Are Solicited on Manufacturing-Related Topics in:

*GaN, GaAs, InP, SiC, ultra-wide bandgap semiconductors, Sb compounds, SiGe, and other related materials*

- **CS Applications:** RF, Power, and Optoelectronic Devices; 5G Devices and Circuits; Automotive sensors; SAW/BAW Filters
- **CS Processing:** Wafer & Device Processing; Equipment; Process Control & Improvement; SixSigma®, CPI, DFM
- **CS Integration:** Packaging & Heterogeneous Integration
- **CS Evaluation:** Test, Yield, Reliability & Failure Analysis
- **CS General:** Business/Market Outlook; Epitaxy & Materials

**Co-located  
events:**  
(planned)



Collaboration and  
innovation across the CS  
supply chain  
May 27<sup>th</sup> - 28<sup>th</sup>  
Visit [www.coinnovatecs.com](http://www.coinnovatecs.com) to learn more



Reliability Of Compound  
Semiconductors Workshop  
May 24<sup>th</sup>

[www.ieedec.org/home/gaas/default.htm](http://www.ieedec.org/home/gaas/default.htm)